DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

X is attached hereto.			
	as United States Apr	olication Number	
	Lication Number		
	(if applic		
I hereby state that I have revie the claims, as amended by any am		its of the above identified speci	fication, includir
I acknowledge the duty to disclo	se information which is mater f Federal Regulations, Section	rial to the patentability of this on 1.56.	application in
I hereby claim foreign priority	benefits under Title 35, Unit	ed States Code, '119(a)-(d) or '	365(b) of any
foreign application(s) for paten	t or inventor's certificate.	or '365(a) of any PCT Internatio	nal application
ov checking the box, any foreign	application for patent or in	States, listed below and have also eventor's certificate, or PCT Int	ernational
application, having a filing dat	e before that of the applicat	ion on which priority is claimed	
Prior Foreign Application(s)			Priority Claim
2000-227996	JAPAN	27/JULY/2000	X_YesNo
(Number)	(Country)	(Day/Month/Year Filed)	YesNo
(Number)	(Country)	(Day/Month/Year Filed)	Yes No
(Number)	(Country)	(Day/Month/Year Filed)	163
I haraby claim the benefit under	35 U.S.C. *119(e) of any Un	ited States provisional applicati	on(s) listed below
	33 8.0.0. 113(0, 01 0)		
I hereby claim the benefit under			
	(Filing Date)		
(Application Number)			
(Application Number)	(Filing Date)		In of any DCT
(Application Number) (Application Number) I hereby claim the benefit under	(Filing Date) 35 U.S.C. '120 of any United States, list	d States Application(s), or '365(iect matter of eac
(Application Number) (Application Number) I hereby claim the benefit under International application design of the claims of this application	(Filing Date) 35 U.S.C. '120 of any United ating the United States, list in is not disclosed in the pri	ed below and, insofar as the sub or United States, or PCT Interna	ject matter of eac tional application
(Application Number) (Application Number) I hereby claim the benefit under International application design of the claims of this application in the manner provided by the fi	(Filing Date) 35 U.S.C. '120 of any United ating the United States, list in is not disclosed in the prince paragraph of 35 U.S.C. '	ed below and, insofar as the sub or United States, or PCT Interna 112, I acknowledge the duty to di	ject matter of eac tional application sclose information
(Application Number) (Application Number) I hereby claim the benefit under International application design of the claims of this application in the manner provided by the filmmaterial to the patentability of	(Filing Date) 35 U.S.C. '120 of any United ating the United States, list in is not disclosed in the prince paragraph of 35 U.S.C. 'this application as defined	ed below and, insofar as the sub or United States, or PCT Interna 112, I acknowledge the duty to di in 37 CFR '1.56 which occurred b	ject matter of eac tional application sclose information etween the filing
(Application Number) (Application Number) I hereby claim the benefit under International application design of the claims of this application in the manner provided by the filmsterial to the patentability of	(Filing Date) 35 U.S.C. '120 of any United ating the United States, list in is not disclosed in the prince paragraph of 35 U.S.C. 'this application as defined	ed below and, insofar as the sub or United States, or PCT Interna 112, I acknowledge the duty to di	ject matter of eac tional application sclose information etween the filing
(Application Number) (Application Number) (Application Number) (Application Number) (Application design of the claims of this application in the manner provided by the finaterial to the patentability of	(Filing Date) 35 U.S.C. '120 of any United ating the United States, list in is not disclosed in the prince paragraph of 35 U.S.C. 'this application as defined	ed below and, insofar as the sub or United States, or PCT Interna 112, I acknowledge the duty to di in 37 CFR '1.56 which occurred b	ject matter of eac tional application sclose information etween the filing cation:

that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor I hereby appoint the following attorney(s) and/or agent(s) to prosecute

POWER OF ATTORNEY: As a named inventor I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith (list name and registration number).

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